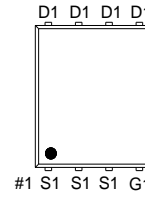
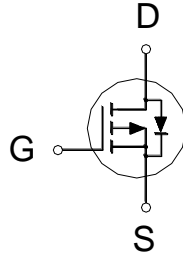


**PRODUCT SUMMARY**

$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D$
-30V	8mΩ	-38A



G : GATE  
D : DRAIN  
S : SOURCE

**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25\text{ °C}$  Unless Otherwise Noted)**

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		$V_{DS}$	-30	V
Gate-Source Voltage		$V_{GS}$	±25	V
Continuous Drain Current	$T_C = 25\text{ °C}$	$I_D$	-38	A
	$T_C = 100\text{ °C}$		-24	
	$T_A = 25\text{ °C}$		-12	
	$T_A = 70\text{ °C}$		-10	
Pulsed Drain Current <sup>1</sup>		$I_{DM}$	-100	
Avalanche Current		$I_{AS}$	-37	
Avalanche Energy	L = 0.1mH	$E_{AS}$	68.4	mJ
Power Dissipation	$T_C = 25\text{ °C}$	$P_D$	20	W
	$T_C = 100\text{ °C}$		8.3	
	$T_A = 25\text{ °C}$		2.3	
	$T_A = 70\text{ °C}$		1.4	
Operating Junction & Storage Temperature Range		$T_j, T_{stg}$	-55 to 150	°C

**THERMAL RESISTANCE RATINGS**

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient <sup>2</sup>	$R_{\theta JA}$		54	°C / W
Junction-to-Case	$R_{\theta JC}$		6	

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25\text{ °C}$ . The value in any given application depends on the user's specific board design.

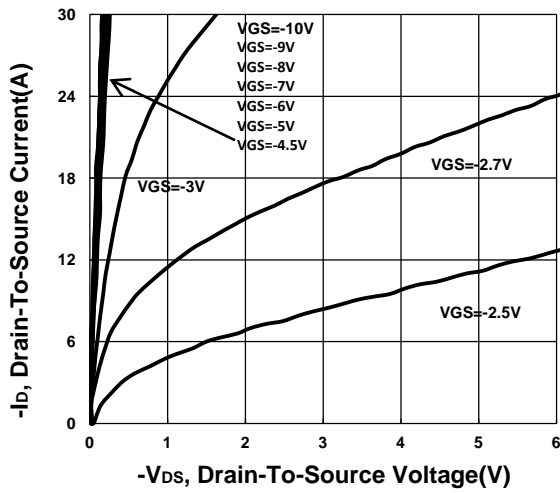
**ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25 °C, Unless Otherwise Noted)**

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-30			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	-1	-1.6	-3	
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±25V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -24V, V <sub>GS</sub> = 0V			-1	uA
		V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 125 °C			-10	
Drain-Source On-State Resistance <sup>1</sup>	R <sub>DS(ON)</sub>	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -12A		8.9	14	mΩ
		V <sub>GS</sub> = -10V, I <sub>D</sub> = -12A		5.9	8	
Forward Transconductance <sup>1</sup>	g <sub>fs</sub>	V <sub>DS</sub> = -5V, I <sub>D</sub> = -12A		40		S
<b>DYNAMIC</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = -15V, f = 1MHz	1971	2464	2956	pF
Output Capacitance	C <sub>oss</sub>		299	374	448	
Reverse Transfer Capacitance	C <sub>rss</sub>		162	271	379	
Gate Resistance	R <sub>g</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 0V, f = 1MHz	2	3.9	5.9	Ω
Total Gate Charge <sup>2</sup>	Q <sub>g(VGS=-10V)</sub>	V <sub>DS</sub> = -15V, I <sub>D</sub> = -12A	48	60	72	nC
	Q <sub>g(VGS=-4.5V)</sub>		22	27.6	33	
Gate-Source Charge <sup>2</sup>	Q <sub>gs</sub>		6.4	8	9.6	
Gate-Drain Charge <sup>2</sup>	Q <sub>gd</sub>		8.2	13.6	19	
Turn-On Delay Time <sup>2</sup>	t <sub>d(on)</sub>			22		
Rise Time <sup>2</sup>	t <sub>r</sub>	V <sub>DS</sub> = -15V,	25			
Turn-Off Delay Time <sup>2</sup>	t <sub>d(off)</sub>	I <sub>D</sub> ≅ -12A, V <sub>GS</sub> = -10V, R <sub>GS</sub> = 6Ω	100			
Fall Time <sup>2</sup>	t <sub>f</sub>		75			
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T<sub>J</sub> = 25 °C)</b>						
Continuous Current	I <sub>S</sub>				-15	A
Forward Voltage <sup>1</sup>	V <sub>SD</sub>	I <sub>F</sub> = -12A, V <sub>GS</sub> = 0V			-1.3.	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = -12A, di <sub>F</sub> /dt = 100 A / μS	7.8	26	44	nS
Reverse Recovery Charge	Q <sub>rr</sub>		3.9	13	22	nC

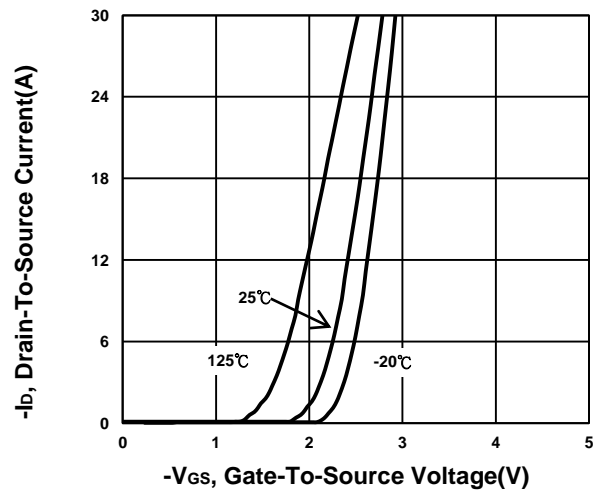
<sup>1</sup>Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

<sup>2</sup>Independent of operating temperature.

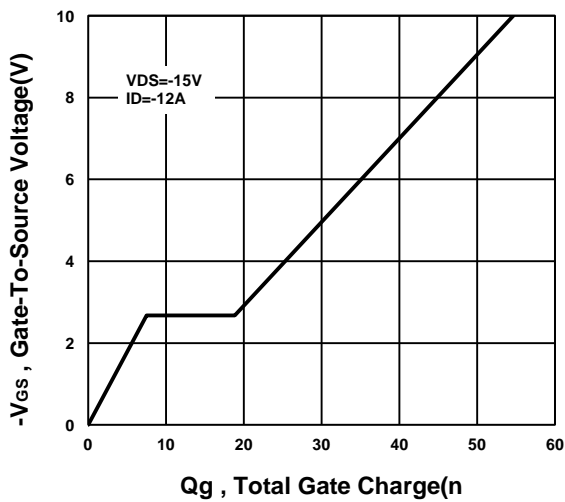
**Output Characteristics**



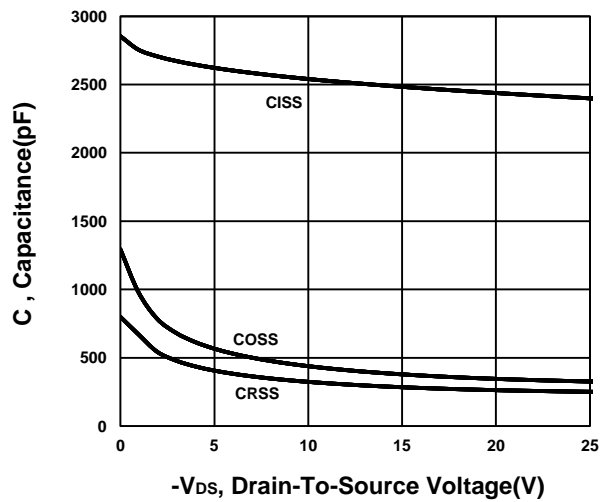
**Transfer Characteristics**



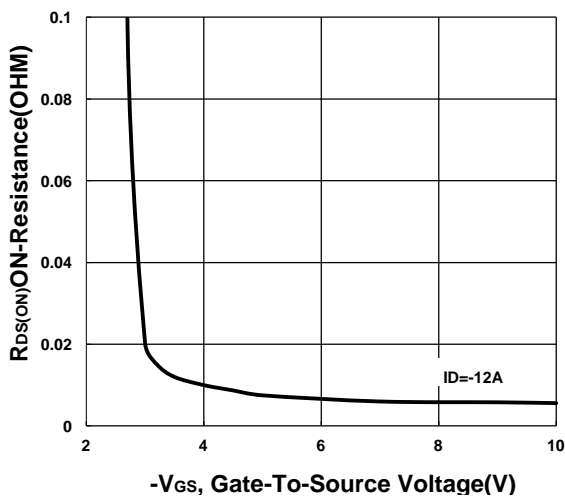
**Gate charge Characteristics**



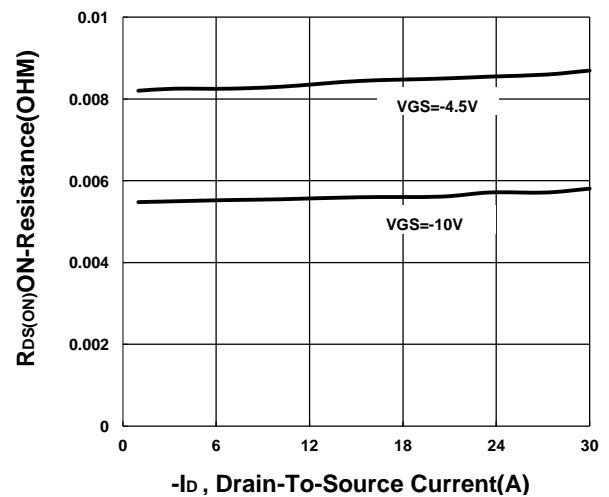
**Capacitance Characteristic**



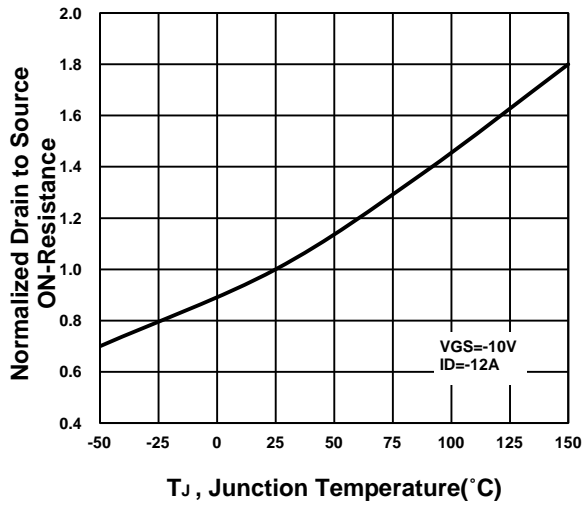
**On-Resistance VS Gate-To-Source**



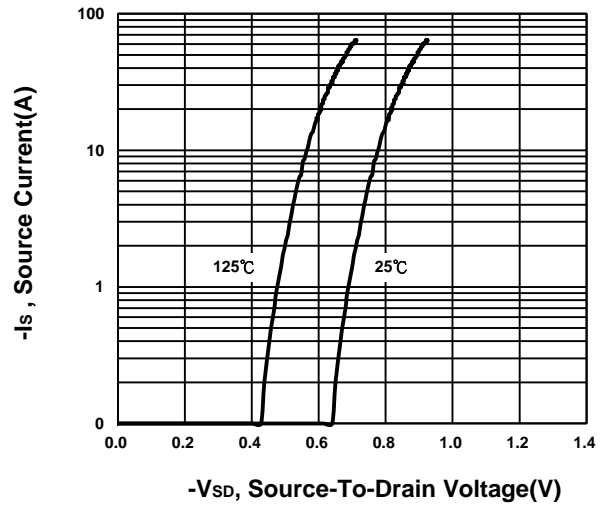
**On-Resistance VS Drain Current**



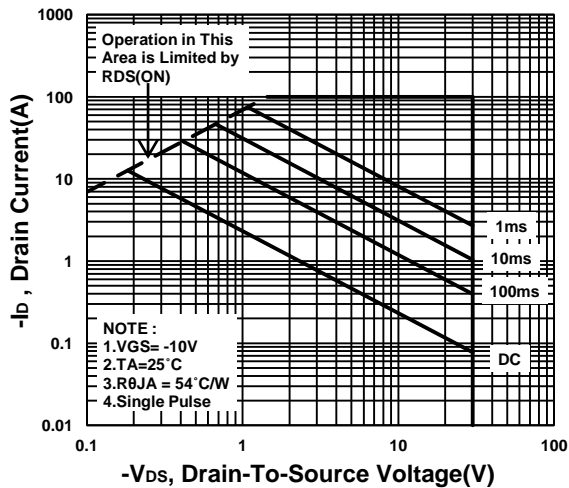
**On-Resistance VS Temperature**



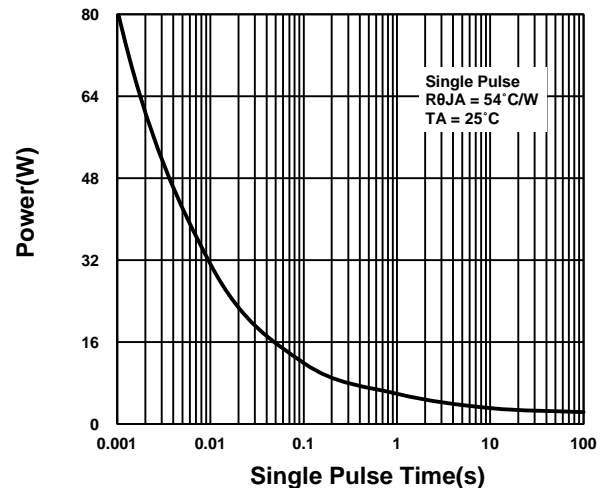
**Source-Drain Diode Forward Voltage**



**Safe Operating Area**



**Single Pulse Maximum Power Dissipation**



**Transient Thermal Response Curve**

